

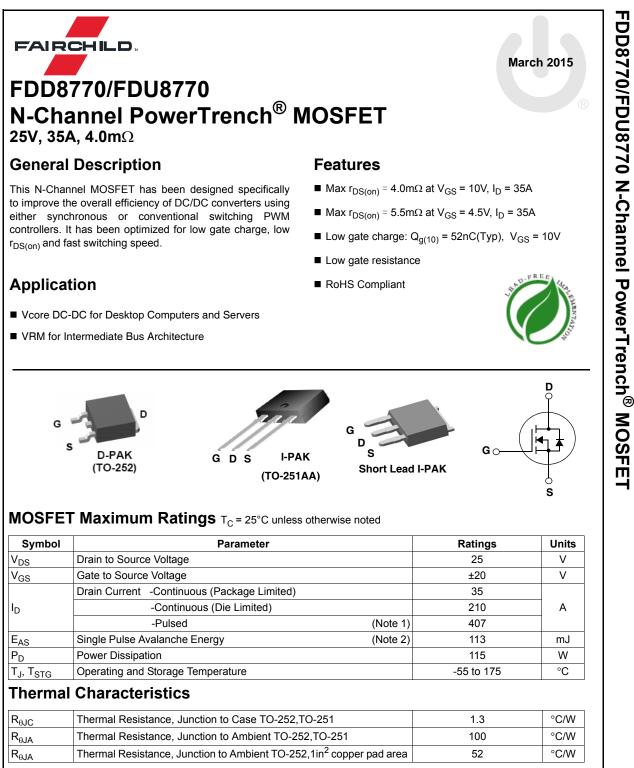
Is Now Part of



## **ON Semiconductor**®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

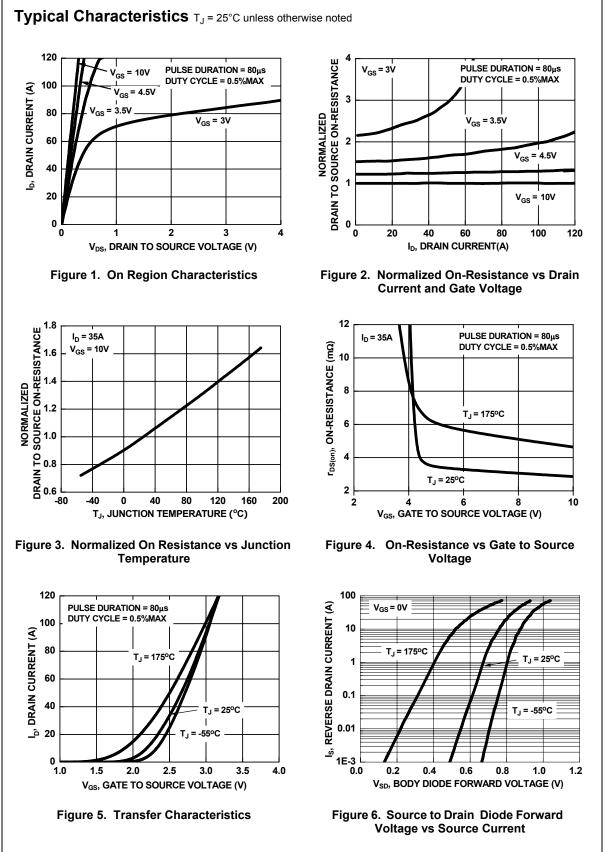
ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconduc

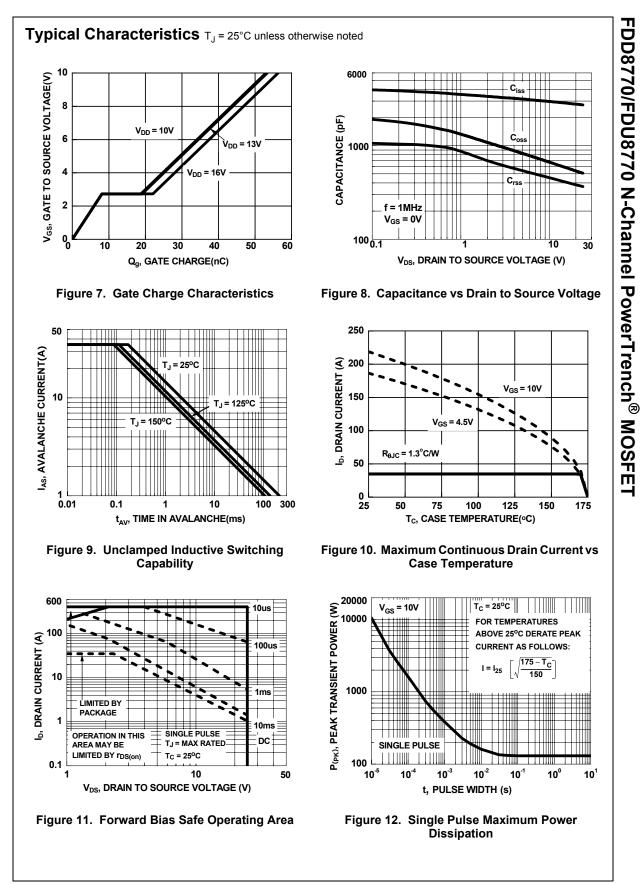


## Package Marking and Ordering Information

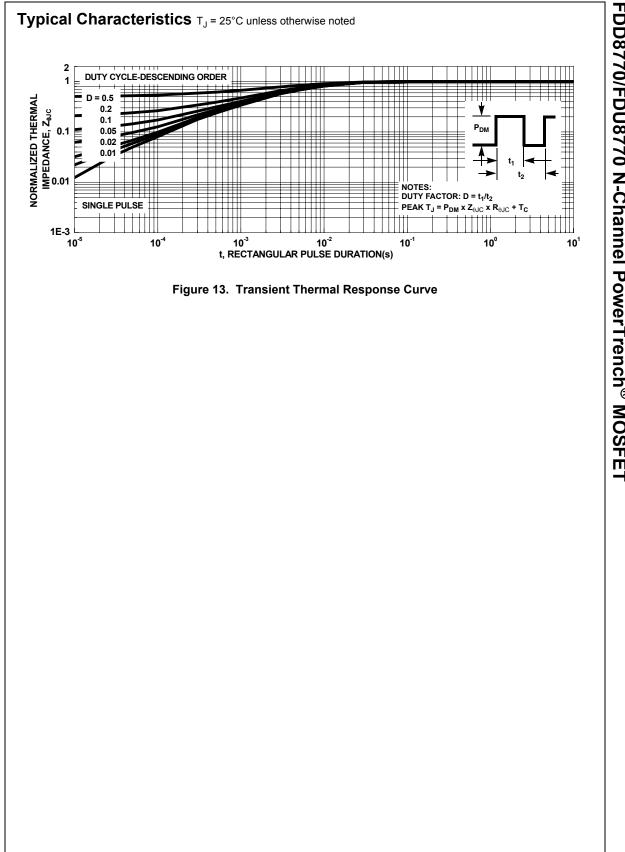
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8770	FDD8770	TO-252AA	13"	16mm	2500 units
FDU8770	FDU8770	TO-251AA	N/A(Tube)	N/A	75 units
FDU8770	FDU8770_F071	TO-251AA	N/A(Tube)	N/A	75 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	25			V
ΔB <sub>VDSS</sub>	Breakdown Voltage Temperature	$I_D = 250 \mu A$ , referenced to		10.0		
$\Delta T_J$	Coefficient	25°C		13.6		mV/°C
I <sub>DSS</sub>	Zero Gale Voltage Drain Current	V <sub>DS</sub> = 20V,			1	μA
055		$V_{GS} = 0V$ $T_J = 150^{\circ}C$			250	50 .
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±20V			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.2	1.6	2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\mu A$ , referenced to $25^{\circ}C$		-5.9		mV/°C
r <sub>DS(on)</sub> Drain to Source On R		V <sub>GS</sub> = 10V, I <sub>D</sub> = 35A		3.3	4.0	-
	Desig to Course On Desigtance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 35A		4.0	5.5	
	Drain to Source On Resistance	$V_{GS} = 10V, I_D = 35A$ T <sub>1</sub> = 175°C		4.8	5.9	_ mΩ
C <sub>oss</sub>	Output Capacitance Reverse Transfer Capacitance	V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V, f = 1MHz		685 450	915 675	pF pF
C <sub>iss</sub>	Input Capacitance	$V_{De} = 13V V_{Ce} = 0V$		2795	3720	pF
C <sub>rss</sub>					675	
R <sub>g</sub>	Gate Resistance	f = 1MHz		1.5		Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	V 40V/L 05A		10	20	ns
t	Rise Time	V <sub>DD</sub> = 13V, I <sub>D</sub> = 35A V <sub>GS</sub> = 10V, R <sub>GS</sub> = 5Ω		12	22	ns
ዣ	Turn-Off Delay Time	VGS 100, NGS 022		49	78	ns
	Taill Oli Belay Tille			25	40	ns
t <sub>d(off)</sub> t <sub>f</sub>	Fall Time					nC
t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Fall Time Total Gate Charge	$V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 13V$		52	73	
t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub>	Fall Time         Total Gate Charge         Total Gate Charge	$V_{\text{DD}} = 0V \text{ to } 5V$ $V_{\text{DD}} = 13V$		29	73 41	nC
Q <sub>gs</sub>	Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Gate Charge			29 8.1	-	nC
t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub>	Fall Time         Total Gate Charge         Total Gate Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 13V$ $I_D = 35A$		29	-	
$t_{d(off)}$ $t_{f}$ $Q_{g}$ $Q_{gs}$ $Q_{gd}$	Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Gate Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 13V$ $I_D = 35A$		29 8.1	-	nC
t <sub>d(off)</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou	Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller"Charge         urce Diode Characteristics	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 13V$ $I_D = 35A$		29 8.1	-	nC nC
$t_{d(off)}$ $t_{f}$ $Q_{g}$ $Q_{gs}$ $Q_{gd}$ <b>Drain-Sou</b>	Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller"Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 13V$ $I_D = 35A$ $I_g = 1.0mA$		29 8.1 11	41	nC
t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller"Charge         urce Diode Characteristics	$V_{GS} = 0V \text{ to } 5V$ $I_D = 35A$ $I_g = 1.0mA$ $V_{GS} = 0V, I_S = 35A$		29 8.1 11 0.84	41	nC nC





FDD8770/FDU8770 Rev. 1.2





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

## PUBLICATION ORDERING INFORMATION

## LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC